

# 2MBI600VXA-120E-50

IGBT Modules

## IGBT MODULE (V series) 1200V / 600A / 2 in one package

### ■ Features

- High speed switching
- Voltage drive
- Low Inductance module structure

### ■ Applications

- Inverter for Motor Drive
- AC and DC Servo Drive Amplifier
- Uninterruptible Power Supply
- Industrial machines, such as Welding machines



### ■ Maximum Ratings and Characteristics

#### ● Absolute Maximum Ratings (at Tc=25°C unless otherwise specified)

Items	Symbols	Conditions	Maximum ratings	Units	
Inverter	Collector-Emitter voltage	$V_{CES}$	1200	V	
	Gate-Emitter voltage	$V_{GES}$	±20	V	
	Collector current	$I_c$	Continuous	Tc=25°C 800	A
				Tc=100°C 600	
		$I_c$ pulse	1ms	1200	
		$-I_c$		600	
Collector power dissipation	$P_c$	$-I_c$ pulse	1ms	1200	
		1 device		3350	W
Junction temperature	$T_j$		175	°C	
Operating junction temperature (under switching conditions)	$T_{jop}$		150		
Case temperature	$T_c$		150		
Storage temperature	$T_{stg}$		-40 ~ +150		
Isolation voltage	$V_{iso}$	AC : 1min.	between terminal and copper base (*1)	4000	VAC
			between thermistor and others (*2)		
Screw torque (*3)	-	Mounting	M5	6.0	N m
		Main Terminals	M8	10.0	
		Sense Terminals	M4	2.1	

Note \*1: All terminals should be connected together during the test.

Note \*2: Two thermistor terminals should be connected together, other terminals should be connected together and shorted to base plate during the test.

Note \*3: Recommendable Value : Mounting 3.0 ~ 6.0 Nm (M5) Recommendable Value : Main Terminals 8.0 ~ 10.0 Nm (M8)  
Recommendable Value : Sense Terminals 1.8 ~ 2.1 Nm (M4)

#### ● Electrical characteristics (at Tj= 25°C unless otherwise specified)

Items	Symbols	Conditions	Characteristics			Units	
			min.	typ.	max.		
Zero gate voltage collector current	$I_{CES}$	$V_{GE} = 0V, V_{CE} = 1200V$	-	-	4.0	mA	
Gate-Emitter leakage current	$I_{GES}$	$V_{CE} = 0V, V_{GE} = \pm 20V$	-	-	800	nA	
Gate-Emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = 20V, I_c = 600mA$	6.0	6.5	7.0	V	
Collector-Emitter saturation voltage	$V_{CE(sat)}$ (terminal) (*4)	$V_{GE} = 15V$ $I_c = 600A$	Tj=25°C	-	1.85	2.30	V
			Tj=125°C	-	2.15	-	
			Tj=150°C	-	2.20	-	
	$V_{CE(sat)}$ (chip)		Tj=25°C	-	1.75	2.20	
			Tj=125°C	-	2.05	-	
			Tj=150°C	-	2.10	-	
Input capacitance	$C_{ies}$	$V_{CE} = 10V, V_{GE} = 0V, f = 1MHz$	-	55	-	nF	
Turn-on time	$t_{on}$	$V_{CC} = 600V$ $I_c = 600A$ $V_{GE} = \pm 15V$ $R_G = 2.4\Omega$	-	1.00	-	µs	
	$t_r$		-	0.40	-		
	$t_r(i)$		-	0.15	-		
	$t_{off}$		-	1.20	-		
Turn-off time	$t_f$		-	0.15	-	µs	
			-	0.15	-		
Forward on voltage	$V_F$ (terminal) (*4)	$V_{GE} = 0V$ $I_F = 600A$	Tj=25°C	-	1.80	2.25	V
			Tj=125°C	-	1.95	-	
			Tj=150°C	-	1.90	-	
	$V_F$ (chip)		Tj=25°C	-	1.70	2.15	
			Tj=125°C	-	1.85	-	
			Tj=150°C	-	1.80	-	
Reverse recovery time	$t_{rr}$	$I_F = 600A$	-	0.20	-	µs	
Resistance	R	T=25°C	-	5000	-	Ω	
		T=100°C	465	495	520		
B value	B	T=25/50°C	3305	3375	3450	K	

Note \*4: Please refer to page 6, there is definition of on-state voltage at terminal.

#### ● Thermal resistance characteristics

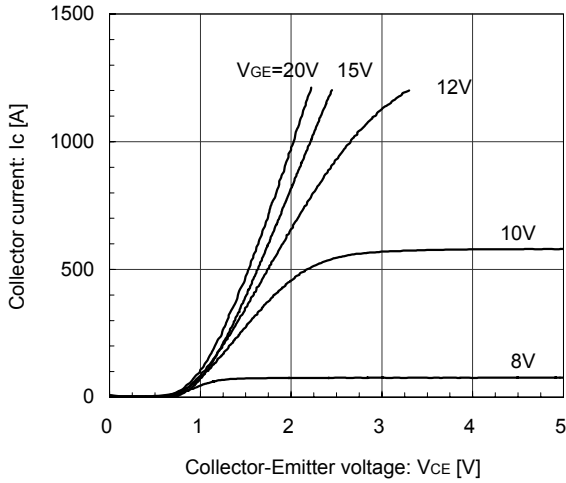
Items	Symbols	Conditions	Characteristics			Units
			min.	typ.	max.	
Thermal resistance (1device)	$R_{th(j-c)}$	Inverter IGBT	-	-	0.045	°C/W
		Inverter FWD	-	-	0.075	
Contact thermal resistance (1device) (*5)	$R_{th(c-f)}$	with Thermal Compound	-	0.0125	-	

Note \*5: This is the value which is defined mounting on the additional cooling fin with thermal compound.

■ Characteristics (Representative)

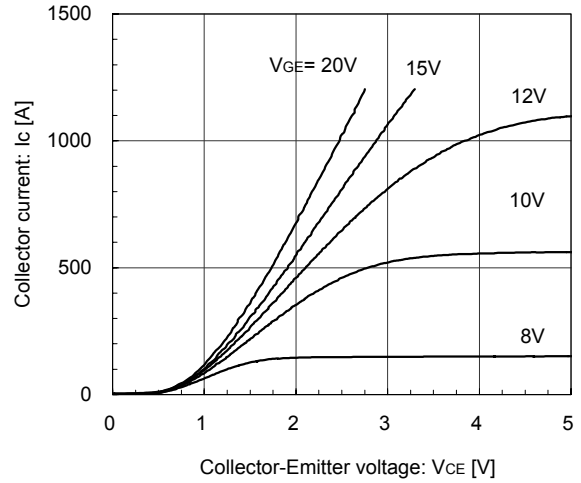
[INVERTER]

Collector current vs. Collector-Emittor voltage (typ.)  
Tj= 25°C / chip



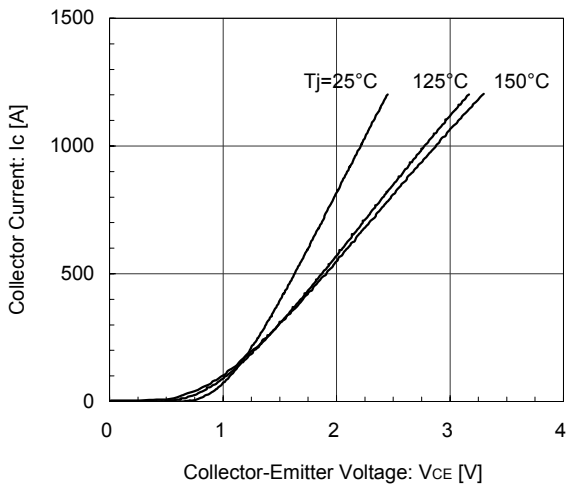
[INVERTER]

Collector current vs. Collector-Emittor voltage (typ.)  
Tj= 150°C / chip



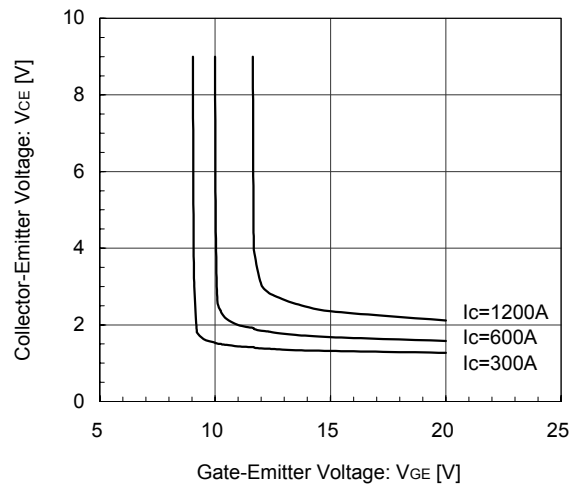
[INVERTER]

Collector current vs. Collector-Emittor voltage (typ.)  
VGE= 15V / chip



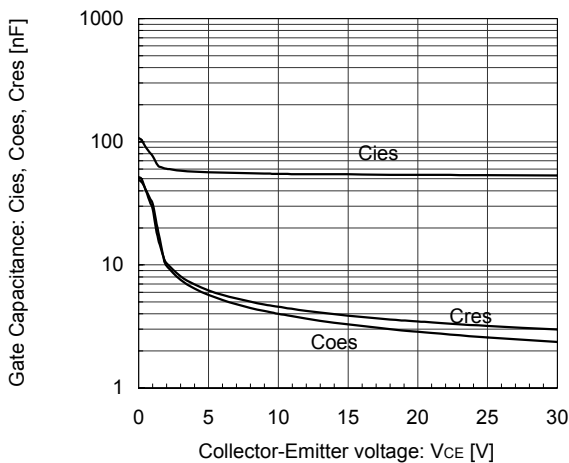
[INVERTER]

Collector-Emittor voltage vs. Gate-Emittor voltage (typ.)  
Tj= 25°C / chip



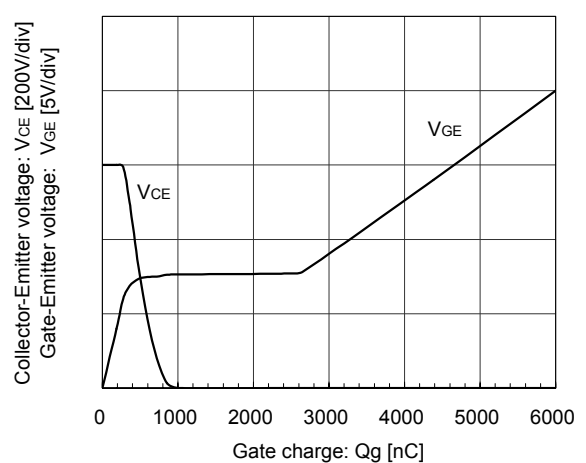
[INVERTER]

Gate Capacitance vs. Collector-Emittor Voltage (typ.)  
VGE= 0V, f= 1MHz, Tj= 25°C



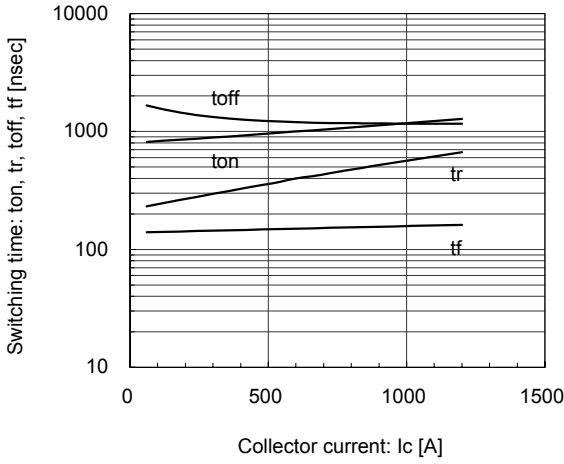
[INVERTER]

Dynamic Gate Charge (typ.)  
Vcc=600V, Ic=600A, Tj= 25°C



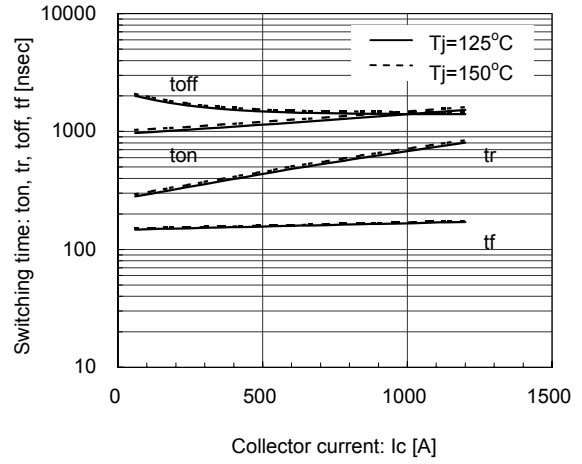
[INVERTER]

Switching time vs. Collector current (typ.)  
 $V_{CC}=600V, V_{GE}=\pm 15V, R_G=2.4\Omega, T_j=25^\circ C$



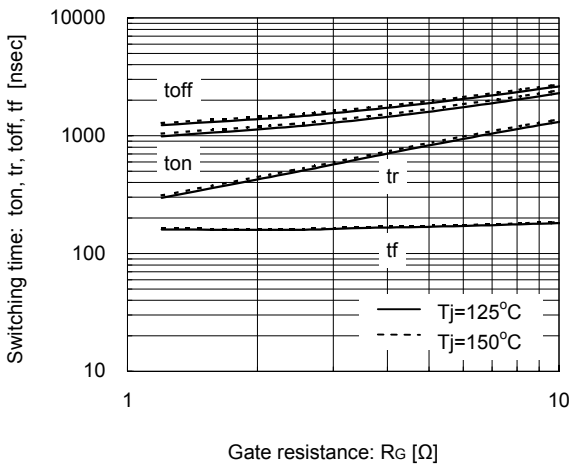
[INVERTER]

Switching time vs. Collector current (typ.)  
 $V_{CC}=600V, V_{GE}=\pm 15V, R_G=2.4\Omega, T_j=125^\circ C, 150^\circ C$



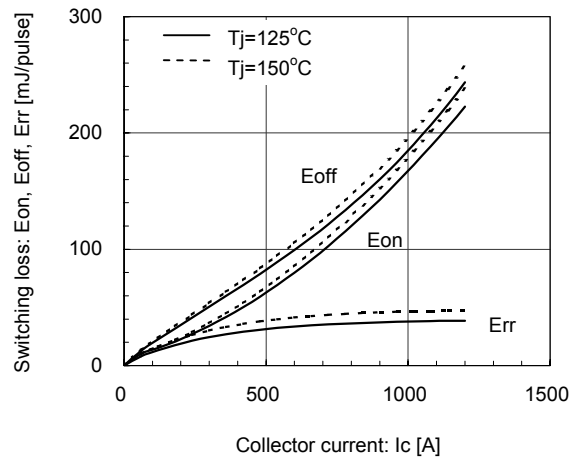
[INVERTER]

Switching time vs. Gate resistance (typ.)  
 $V_{CC}=600V, I_c=600A, V_{GE}=\pm 15V, T_j=125^\circ C, 150^\circ C$



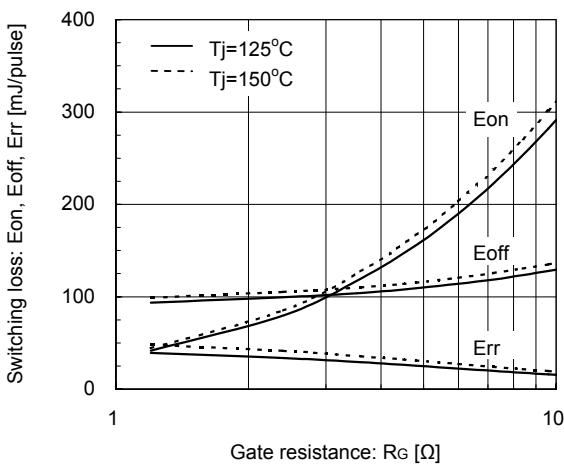
[INVERTER]

Switching loss vs. Collector current (typ.)  
 $V_{CC}=600V, V_{GE}=\pm 15V, R_G=2.4\Omega, T_j=125^\circ C, 150^\circ C$



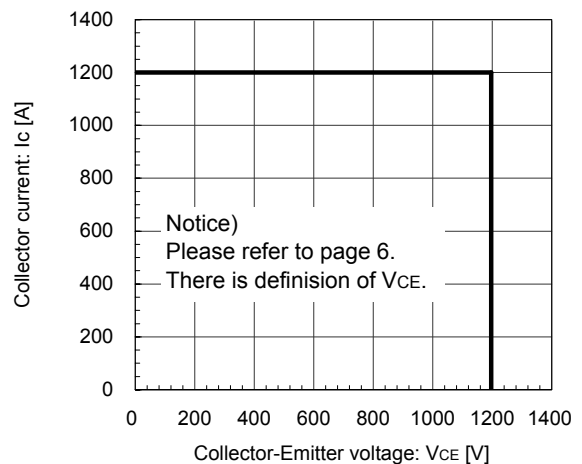
[INVERTER]

Switching loss vs. Gate resistance (typ.)  
 $V_{CC}=600V, I_c=600A, V_{GE}=\pm 15V, T_j=125^\circ C, 150^\circ C$



[INVERTER]

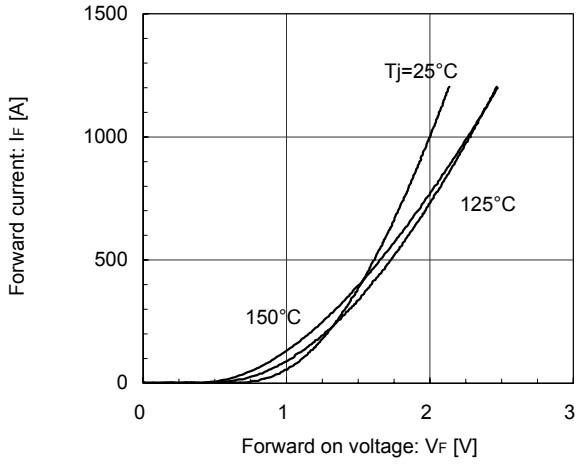
Reverse bias safe operating area (max.)  
 $+V_{GE}=15V, -V_{GE}=15V, R_G=2.4\Omega, T_j=150^\circ C$



Notice)  
 Please refer to page 6.  
 There is definition of  $V_{CE}$ .

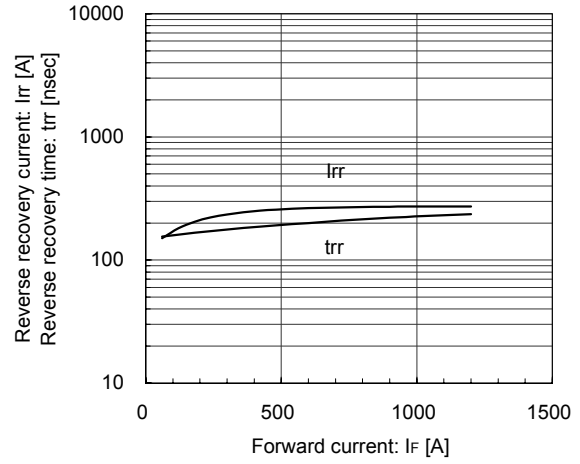
[INVERTER]

Forward Current vs. Forward Voltage (typ.)  
chip



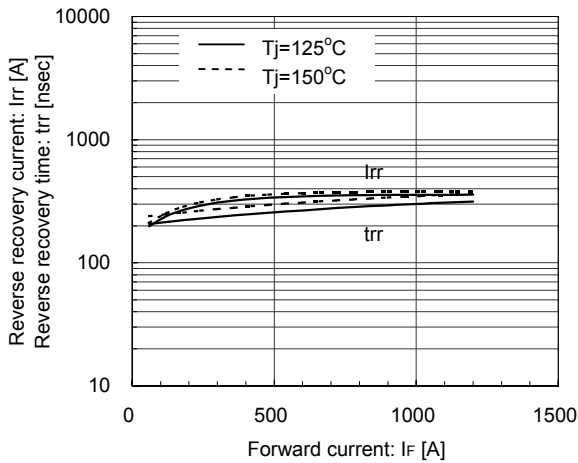
[INVERTER]

Reverse Recovery Characteristics (typ.)  
 $V_{CC}=600\text{V}$ ,  $V_{GE}=\pm 15\text{V}$ ,  $R_G=2.4\Omega$ ,  $T_j=25^\circ\text{C}$

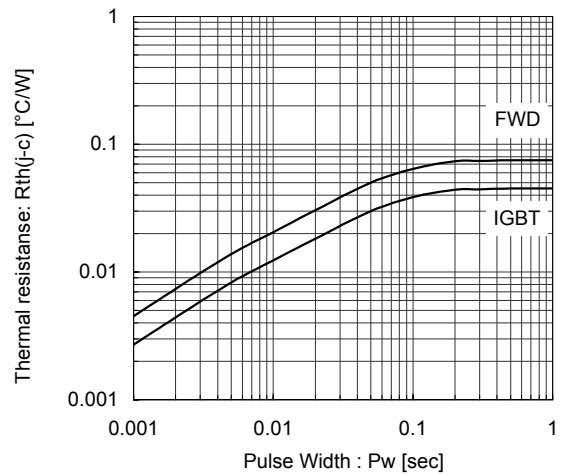


[INVERTER]

Reverse Recovery Characteristics (typ.)  
 $V_{CC}=600\text{V}$ ,  $V_{GE}=\pm 15\text{V}$ ,  $R_G=2.4\Omega$ ,  $T_j=125^\circ\text{C}$ ,  $150^\circ\text{C}$

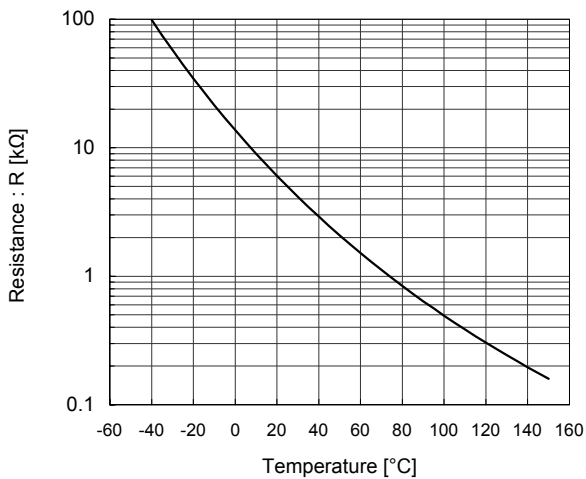


Transient Thermal Resistance (max.)

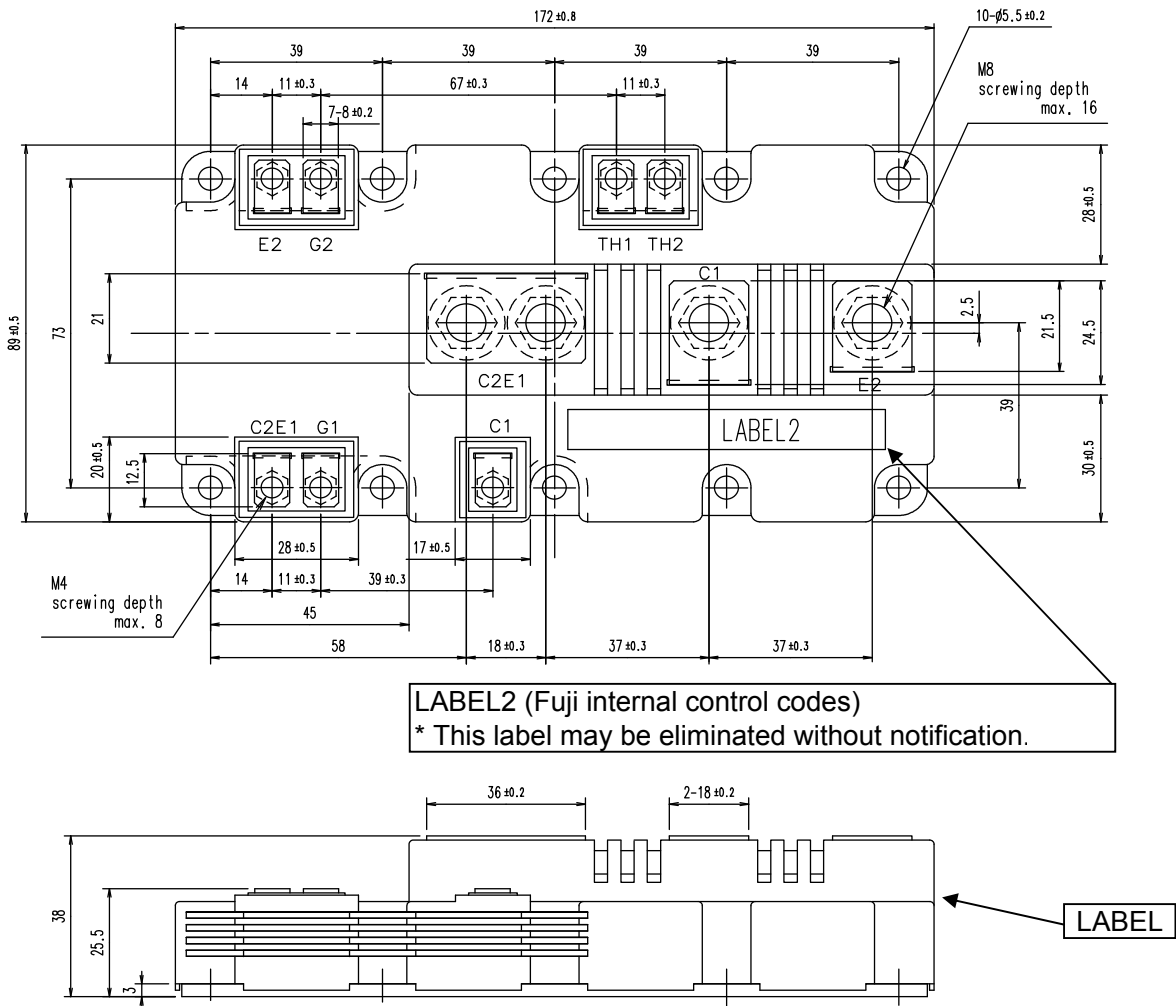


[THERMISTOR]

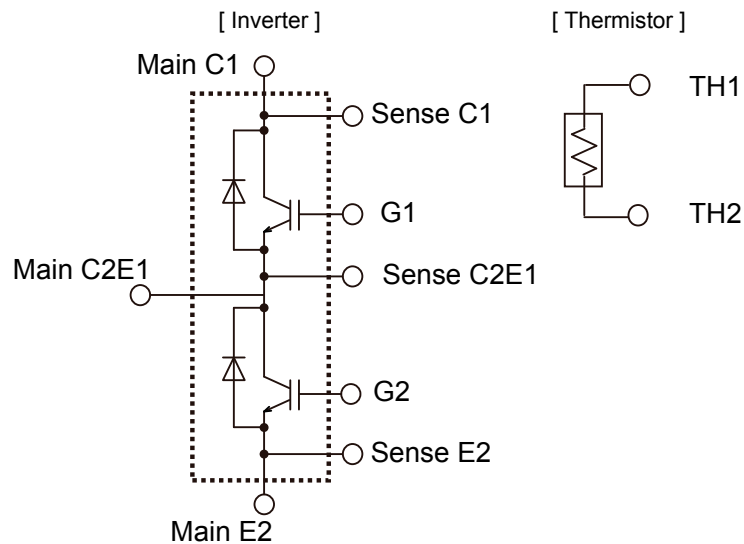
Temperature characteristic (typ.)



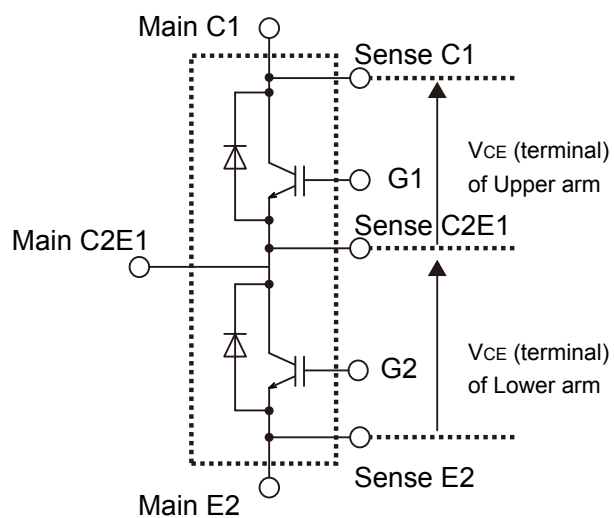
■ Outline Drawings, mm



■ Equivalent Circuit Schematic



### ■ Definition of on-state voltage at terminal and switching characteristics



Fuji defined  $V_{CE}$  value of terminal by using Sense C1 and Sense C2E1 for Upper arm and Sense C2E1 and Sense E2 for Lower arm .

Switching characteristics of  $V_{CE}$  also is defined between Sense C1 and Sense C2E1 for Upper arm and Sense C2E1 and Sense E2 for Lower arm .

Please use these terminals whenever measure spike voltage and on-state voltage .

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